

Highbright 0201 ChipLED



DESCRIPTION

The 0201 ChipLED delivers brilliant illumination in one of the smallest surface-mount formats available. Measuring just 0.65 mm x 0.375 mm x 0.35 mm, it is perfectly suited for space-constrained applications in consumer electronics, wearables, industrial systems, and more. This RoHS-compliant component combines ultra compact dimensions, low power consumption, a wide viewing angle, and multiple color options engineered for seamless integration into automated SMT processes. Offering exceptional versatility and performance, the 0201 ChipLED empowers the next generation of compact, high efficiency electronic designs.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD 0201 ChipLED
- Product series: standard
- Angle of half intensity: $\pm 60^\circ$

FEATURES

- Super small ChipLED with high brightness 0.65 x 0.375 x 0.35 (L x W x H in mm)
- High reliability PCB based
- Typical color coordinates: x, y = 0.41, 0.23
- High efficient InGaN technology
- Wide viewing angle: 120°
- Grouping parameter: luminous intensity, CIE 1931 chromaticity coordinates, and forward voltage
- Available in 8 mm tape on 7" diameter reel
- ESD sensitive device, HBM 1000 V
- Compatible to IR reflow soldering
- Preconditioning according to JEDEC® level 3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- Backlighting for keypads, logos, and buttons in ultra-thin devices
- Instrument illumination
- Indicators and backlight for telecommunication equipment, consumer electronics, and white goods
- Displays for industrial control systems
- Next-generation compact devices and smart accessories
- General use

PARTS TABLE

PART	COLOR	LUMINOUS INTENSITY (mcd)			at I _F (mA)	COLOR COORDINATES (x, y)			at I _F (mA)	FORWARD VOLTAGE (V)			at I _F (mA)	TECHNOLOGY
		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		
VLMM1700-GS08	Magenta	11.5	-	45	2	-	0.41, 0.23	-	2	2.4	-	3.1	2	InGaN / sapphire



ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
VLMM170. (InGaN technology)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage ⁽¹⁾		V_R	5	V
DC forward current		I_F	5	mA
Surge forward current	1/10 duty cycle, 0.1 ms pulse width	I_{FSM}	10	mA
Power dissipation	$T_{amb} \leq 25\text{ }^{\circ}\text{C}$	P_V	15	mW
Operating temperature range		T_{amb}	-40 to +85	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	-40 to +90	$^{\circ}\text{C}$
ESD withstand voltage	HBM	V_{ESD}	1000	V
Reflow solder conditions	According Vishay specifications	T_{sld}	260	$^{\circ}\text{C}$

Note

- ⁽¹⁾ Reverse voltage is intended for test purposes only; do not operate the device under reverse bias

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
VLMM170., MAGENTA						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity	$I_F = 2\text{ mA}$	I_V	11.5	-	45	mcd
CIE 1931 chromaticity coordinates x, y	$I_F = 2\text{ mA}$	λ_d	-	0.41, 0.23	-	nm
Angle of half intensity	$I_F = 2\text{ mA}$	φ	-	± 60	-	$^{\circ}$
Forward voltage	$I_F = 2\text{ mA}$	V_F	2.4	-	3.1	V
Reverse current	$V_R = 5\text{ V}$	I_R	-	-	50	μA

LUMINOUS INTENSITY CLASSIFICATION AT 2 mA		
GROUP	LUMINOUS INTENSITY (mcd)	
	MIN.	MAX.
L	11.5	18
M	18	28.5
N	28.5	45

Note

- Tolerance of luminous intensity: $\pm 11\%$

FORWARD VOLTAGE CLASSIFICATION AT 2 mA		
GROUP	FORWARD VOLTAGE (V)	
	MIN.	MAX.
X	2.4	2.75
Y	2.75	3.1

Note

- Tolerance of forward voltage: $\pm 0.05\text{ V}$

CIE 1931 COLOR CLASSIFICATION AT 2 mA		
GROUP	X	Y
PP1	0.357	0.16
	0.357	0.26
	0.407	0.28
	0.407	0.18
PP2	0.407	0.18
	0.407	0.28
	0.457	0.3
	0.457	0.2

Note

- Tolerance of chromaticity coordinate groups: ± 0.01

Notes

- In order to ensure availability, single groups for luminous intensity, color, and forward voltage will not be orderable
- Only one group for luminous intensity, dominant wavelength, and forward voltage will be shipped in any one reel

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

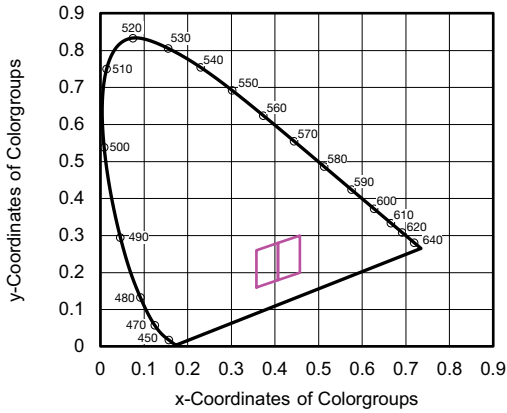


Fig. 1 - Coordinates of Color Groups VLMM1700

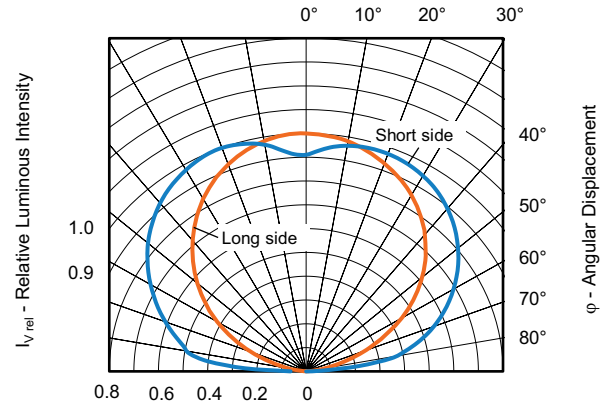


Fig. 4 - Relative Luminous Intensity vs. Angular Displacement

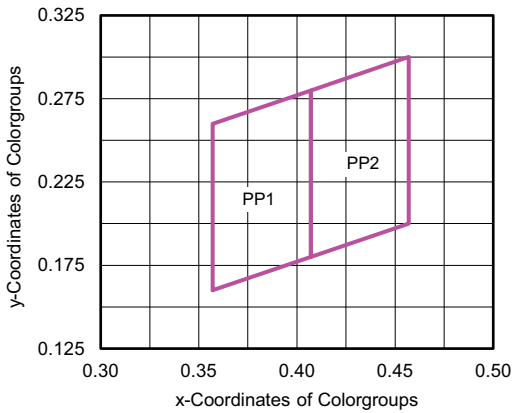


Fig. 2 - Coordinates of Color Groups VLMM1700

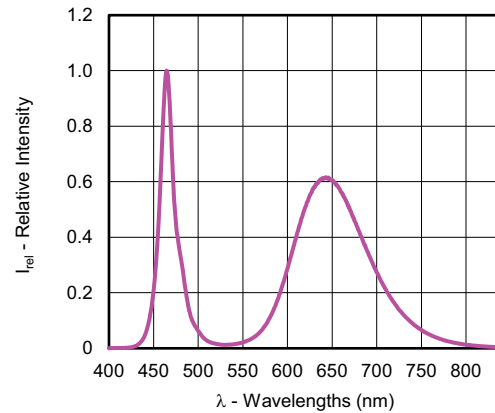


Fig. 5 - Relative Intensity vs. Wavelength

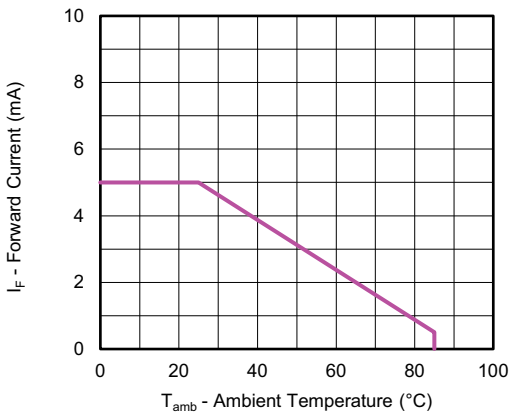


Fig. 3 - Forward Current vs. Ambient Temperature

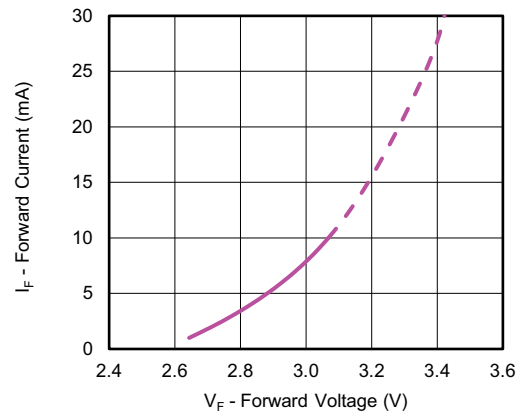


Fig. 6 - Forward Current vs. Forward Voltage

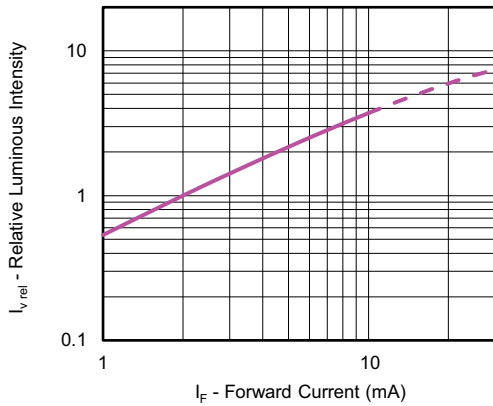


Fig. 7 - Relative Luminous Intensity vs. Forward Current

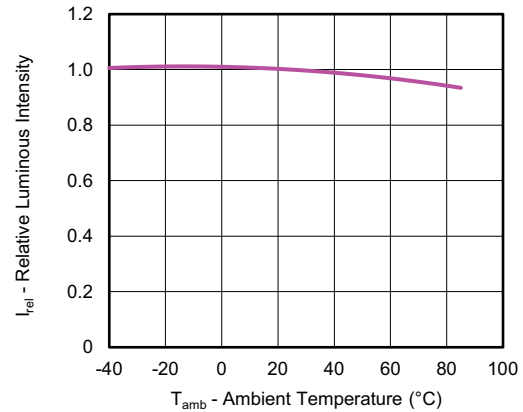


Fig. 10 - Relative Luminous Intensity vs. Ambient Temperature

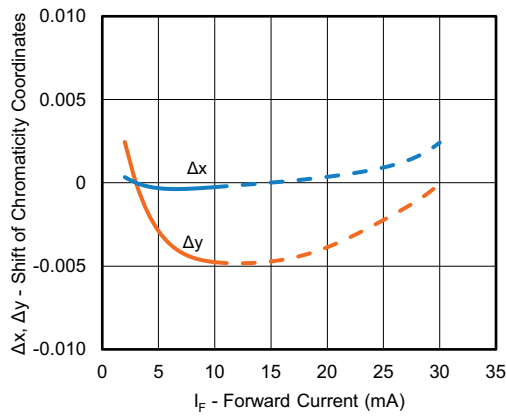


Fig. 8 - Shift of Chromaticity Coordinates vs. Forward Current

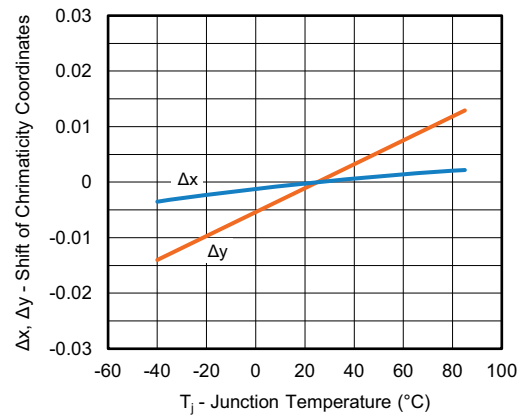


Fig. 11 - Shift of Chromaticity Coordinates vs. Junction Temperature

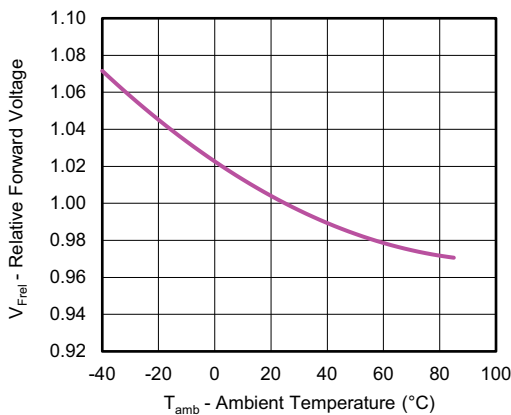
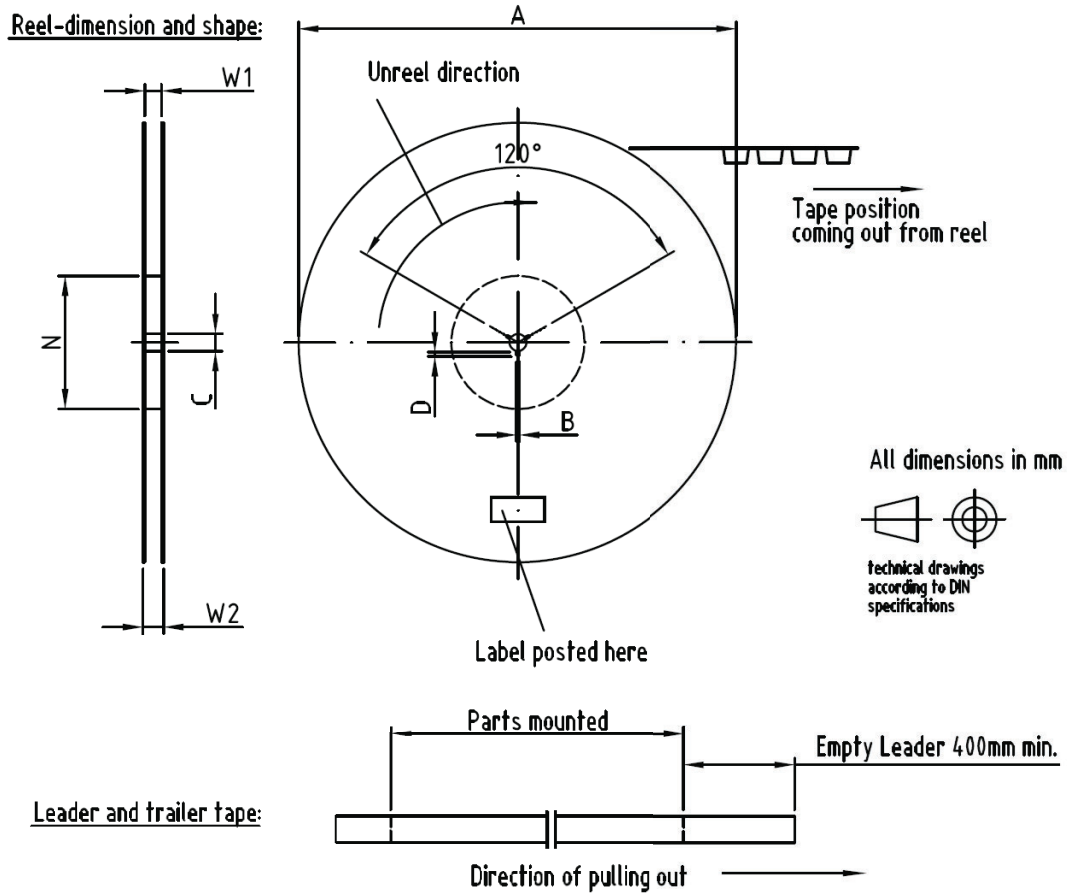


Fig. 9 - Relative Forward Voltage vs. Ambient Temperature

REEL DIMENSIONS in millimeters


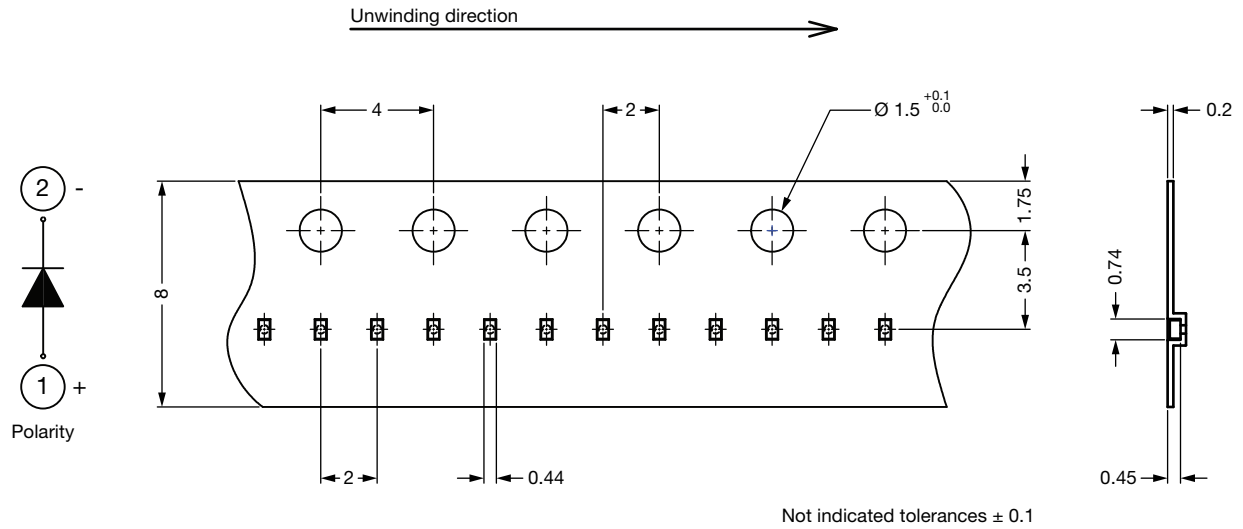
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Issue: VK; 18.04.24

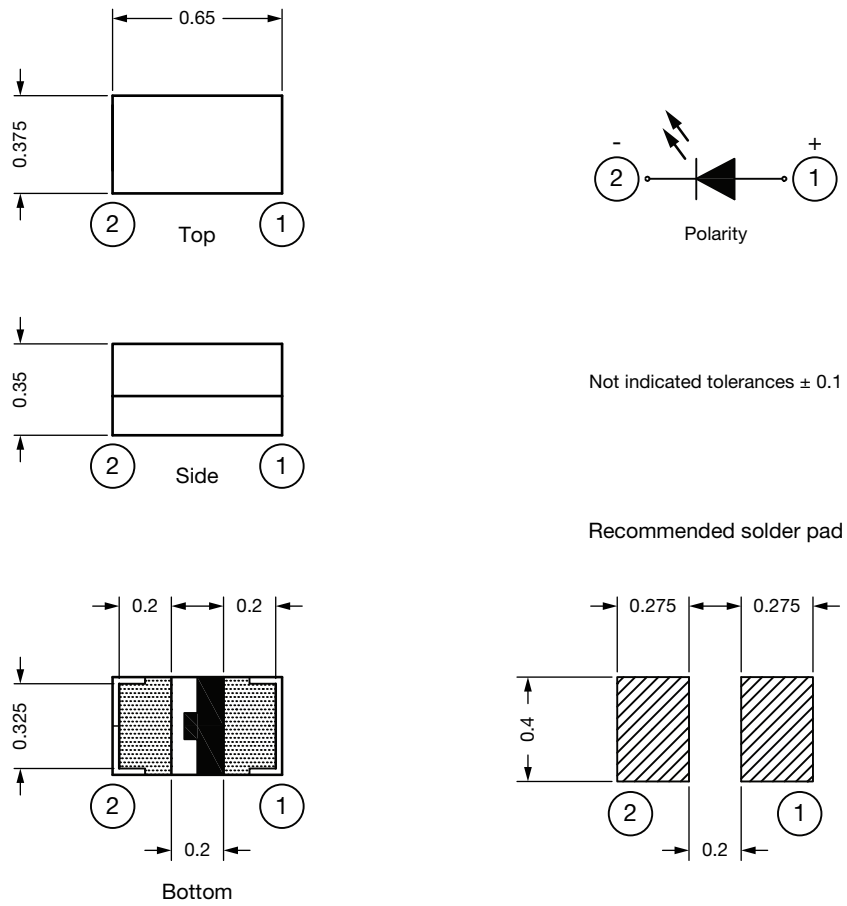
DIMENSIONS OF REEL in millimeters (according drawing reference)							
TAPING VERSION	A	B	C	D	N	W1	W2
GS08	$\varnothing 180 \pm 2$	2 ± 0.5	$\varnothing 13 \pm 0.2$	-	$\varnothing 60 + 0 / - 1$	$9 + 0.3 / - 0$	11.4 ± 1

Reels come in quantity of 3000 units.

TAPE DIMENSIONS in millimeters



PACKAGE DIMENSIONS in millimeters



Note

- Suggested pad dimensions for reference only; please modify the pad dimensions based on individual need

SOLDERING PROFILE

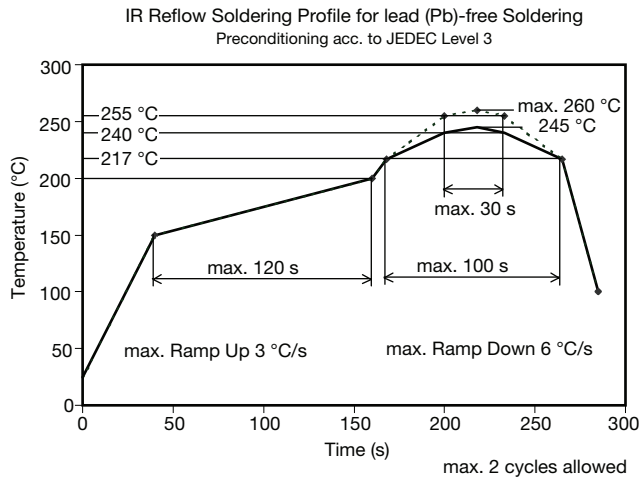
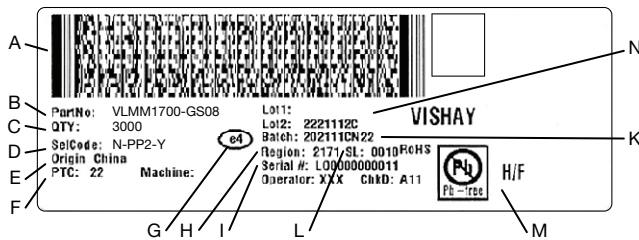


Fig. 12 - Vishay Lead (Pb)-free Reflow Soldering Profile (according to J-STD-020C)

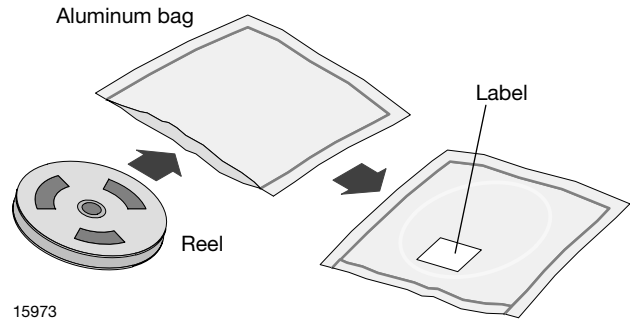
BAR CODE PRODUCT LABEL (Example only)



- A. 2D barcode
- B. Part No: Vishay part number
- C. QTY: quantity
- D. SelCode: selection bin code
- E. Country of origin
- F. PTC: product plant code
- G. Termination finish
- H. Region code
- I. Serial#: serial number
- K. Batch Number: year, week, country code, plant code
- L. SL: storage location
- M. Environmental Symbols: RoHS, lead (Pb)-free, halogen-free
- N. Lot numbers

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the condition given in J-STD-033.

A JEDEC J-STD-033 level 3 label is included on all aluminum dry bags.

CAUTION
This bag contains
MOISTURE-SENSITIVE DEVICES

LEVEL (MSL)

3

1. Calculated shelf life in sealed bag: 12 months at < 40°C and < 90% relative humidity (RH)
2. Peak package body temperature: 260°C
3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be
 - a) Mounted within **168 h** of factory conditions ≤ 30°C/60%RH, or
 - b) Stored per J-STD-033.
4. Devices require bake before mounting, if:
 - a) Humidity Indicator Card reads >10% for level 2a - 5a devices or > 60% for level 2 devices when read at 23°C ± 5°C
 - b) 3a or 3b are not met
5. If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure

Bag Seal Date: _____
If blank, see adjacent bar code label

Note: Level (MSL) and body temperature defined by IPC/JEDEC J-STD-020

Example of JEDEC J-STD-033 Level 3 Label



ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

**VISHAY SEMICONDUCTORS STANDARD
BAR CODE LABELS**

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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